

Thrust B

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# Ozonated Water Research Directions

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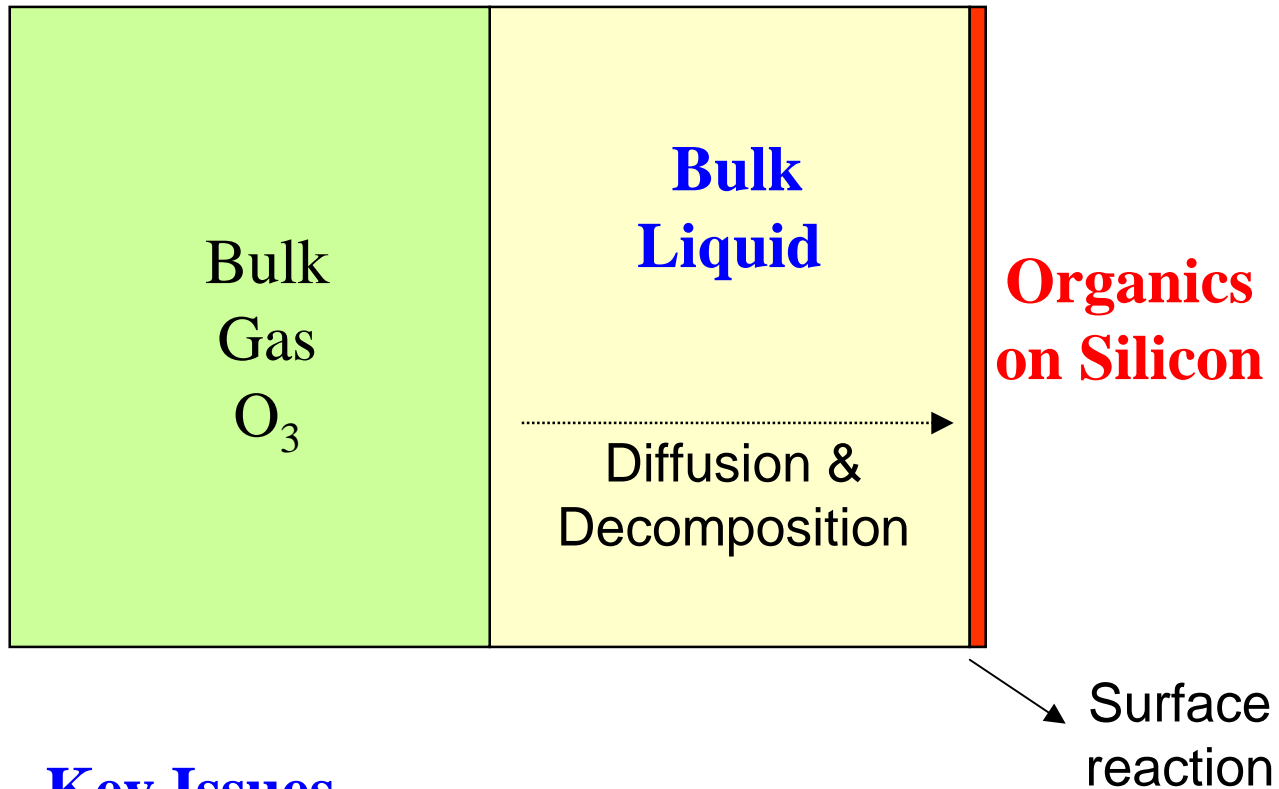
# Ozonated Water Cleaning Impact

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Resist striping & replacement for Piranha cleaning

- CoO; 29% reduction compared to piranha.
- Environmental Gain
  - Eliminates most  $H_2SO_4$  use and waste.
  - Less UPW use, due to elimination of  $H_2SO_4$  rinse.
- Safety
  - Eliminates exposure to hot piranha
  - Need to learn how to handle  $O_3$  safely.

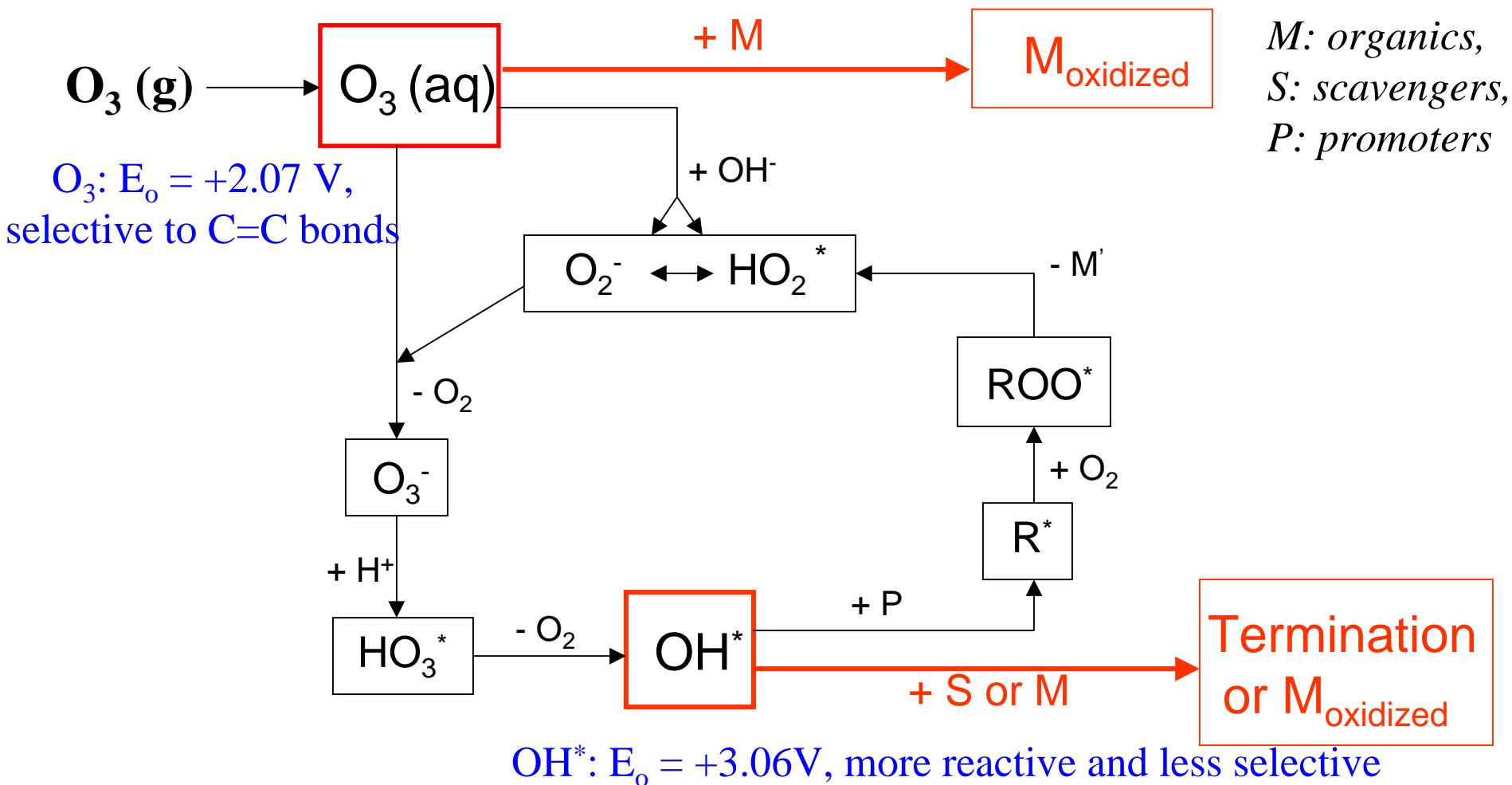
# Process



## Key Issues

- **Boundary Layer Control**
- **$O_3$  Decomposition**

# O<sub>3</sub> Decomposition Model



# Chain Reaction Chemistry

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1. Direct consumption of  $O_3$ , e.g., phenol
2. Initiation of  $O_3$  decomposition, e.g.,  $OH^-$ , glyoxylic acid
3. Propagation, e.g., formic acid, methanol  
( $OH^*$  scavenged, but  $O_2^{*-}$  reformed.)
4. Termination, e.g., tert-butanol,  $HCO_3^-$ ,  $CO_3^{2-}$   
( $OH^*$  scavenged, and no  $O_2^{*-}$  or  $H_2O_2$  formed.)

# Cleaning Parameters

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S. De Gendt et al., *Symp. on VLSI Technol.* p.168, 1998.

- pH  $\uparrow$  :  $[O_3]$   $\downarrow$
- promoter addition  $[H_2O_2]$   $\uparrow$  :  $[OH^*]$   $\uparrow$ ,  $[O_3]$   $\downarrow$ ,  
resist removal  $\downarrow$
- inhibitor addition  $[CH_3COOH]$   $\uparrow$  :  $[OH^*]$   $\downarrow$ ,  $[O_3]$   $\nearrow$ ,  
resist removal  $\nearrow$
- Temperature  $\uparrow$  :  $[O_3]$   $\downarrow$ , but removal efficiency/ $[O_3]$   $\uparrow$

What is the chemical structure of various resists?  
What are the water-soluble etch products?

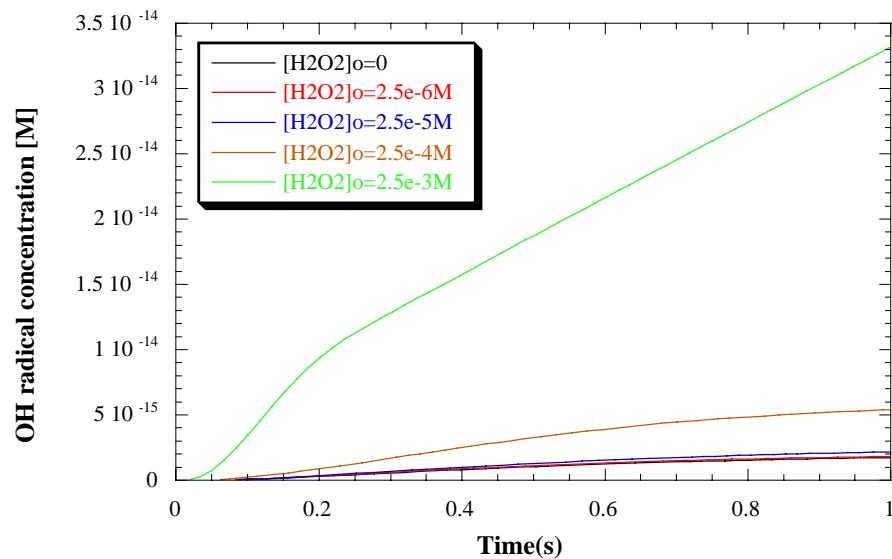
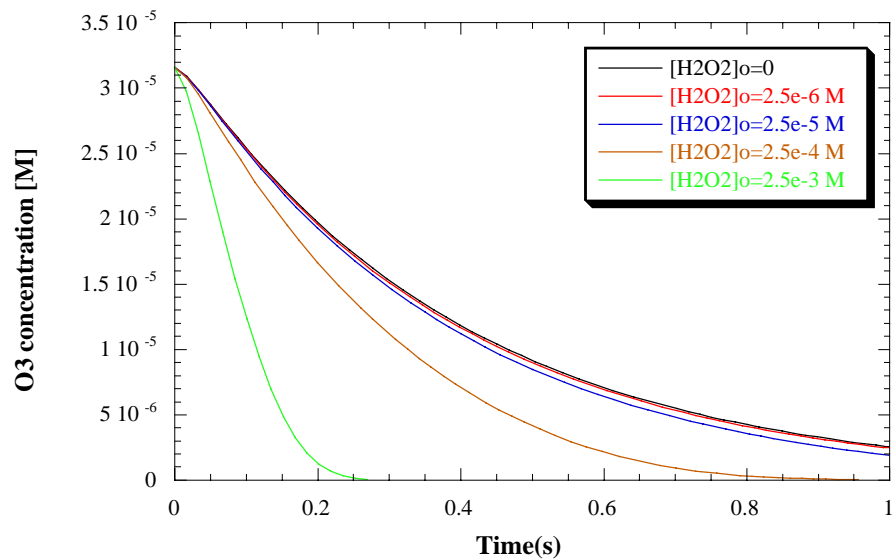
# Numerical Simulation

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- Simulates direct and indirect oxidant concentrations.
- Predict the distribution of intermediate species.
- Examines the kinetic roles of scavengers and promoters on  $O_3$  and  $OH^*$  concentrations

# Simulation Results

$[\text{O}_3]_0 = 3.16 \times 10^{-5} \text{ M}$ ,  $[\text{OH}^-]_0 = 7.17 \times 10^{-3} \text{ M}$ ,  $[\text{CO}_3^{2-}]_0 = 3.0 \times 10^{-3}$





# Some Questions

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- Which oxidation is preferred, direct or indirect?
  - What is the oxidation mechanism of resist?
  - What is the main etch species,  $O_3$  or  $OH^*$ ?
- Is the decomposition model realistic?

# Future Work

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- Gathering all kinetic data and Remodeling.
- Combining of simulation and experimental data.
- Elucidating O<sub>3</sub> decomposition and cleaning efficiency.
  - pH,
  - scavengers,
  - promoters.....